

2A, 60V Trench Schottky Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Patented Trench Schottky technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive

MECHANICAL DATA

- Case: Micro SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.006g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	2	Α	
V_{RRM}	60	V	
I _{FSM}	30	Α	
T_{JMAX}	175	°C	
Package	Micro SMA		
Configuration	Single die		









Micro SMA



PARAMETER		SYMBOL	TSU2M60H	UNIT
Marking code on the device			Z4	
Repetitive peak reverse voltage		V_{RRM}	60	V
Reverse voltage, total rms value		$V_{R(RMS)}$	42	V
Forward current		I _F	2	А
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms		30	А
	t = 1.0ms	IFSM	80	А
Junction temperature		TJ	- 55 to +175	°C
Storage temperature		T _{STG}	- 55 to +175	°C

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R _{eJL}	19	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	68	°C/W
Junction-to-case thermal resistance	R _{eJC}	33	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1A, T_J = 25^{\circ}C$		0.58	-	V
	$I_F = 2A, T_J = 25^{\circ}C$	V _F	0.72	0.81	V
	$I_F = 1A, T_J = 125$ °C		0.52	-	V
	I _F = 2A, T _J = 125°C		0.68	0.77	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	I _R	-	100	μA
	T _J = 125°C		-	5	mA
Junction capacitance	1MHz, $V_R = 4.0V$	CJ	100	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSU2M60H	Micro SMA	12,000 / Tape & Reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

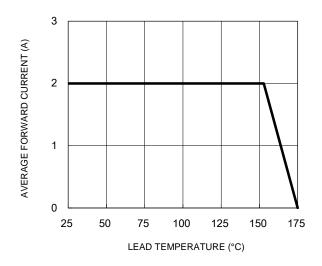


Fig.3 Typical Reverse Characteristics

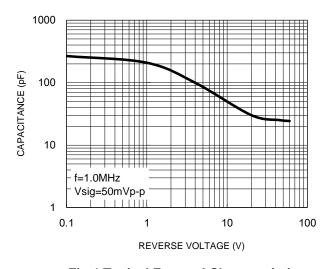
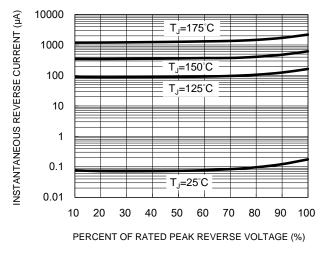


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



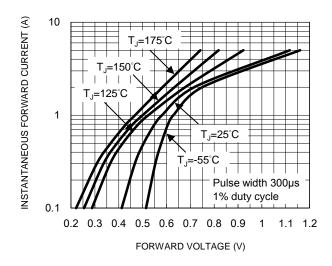
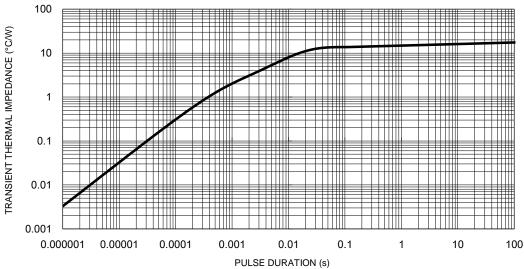


Fig.5 Typical Transient Thermal Impedance

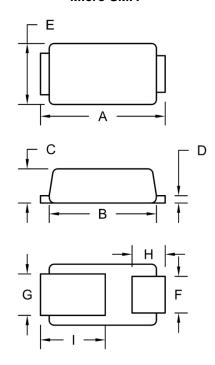


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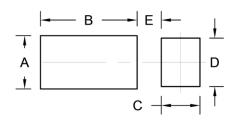
PACKAGE OUTLINE DIMENSIONS

Micro SMA



DIM.	Unit (mm)		Unit ((inch)
DIIVI.	Min.	Max.	Min.	Max.
Α	2.30	2.70	0.091	0.106
В	2.10	2.30	0.083	0.091
С	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	0.75	0.95	0.030	0.037
Н	0.55	0.75	0.022	0.030
I	1.10	1.50	0.043	0.059

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.10	0.043
В	2.00	0.079
С	0.80	0.031
D	1.00	0.039
E	0.50	0.020

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



P/N = Marking Code

YW = Date Code



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